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The 1st International Conference on Al Sensors and The 10th International Symposium on Sensor Science

I3S
2024
Conference

1-4 August 2024, Singapore

LETTER OF INVITATION

Prof. Daquan Yang
School of Information and Commi

School of Information and Communication Engineering Beijing University of Posts and Telecommunications Beijing, China

Email: ydq@bupt.edu.cn

April 11, 2024

Dear Prof. Daquan Yang,

The 1st International Conference on AI Sensors
The 10th International Symposium on Sensor Science
Singapore

Email: ais-i3s2024@mdpi.com

Website: https://sciforum.net/event/aisi3s2024

The 1st International Conference on AI Sensors & The 10th International Symposium on Sensor Science (AIS-I3S 2024) will be held at National University of Singapore, Singapore from 1 to 4 August 2024, chaired by Prof. Chengkuo Lee, Prof. Guangya Zhou, and Prof. Po-Liang Liu.

The I3S Conference series has come to its 10th edition, evolving into a premier annual event in the sensors community. In recent years it has attracted over 400 participants and has presented more than 200 select papers in non-overlapping oral and poster sessions. Together with AI Sensors 2024, we expect to host 600+ participants worldwide. This conference gathers academic leaders, pioneers, engineers, students and visionaries from sensors and AI communities to share their cutting-edge technologies in emerging fields.

On behalf of the Organizing Committee, I cordially invite you to participate as an **Invited Speaker** to present your research activities. I believe your expertise and experience would enhance the conference. Please feel free to contact us if you have any questions.

I hope to welcome you to AIS-I3S 2024 in August.

Yours Sincerely,
Dr. Chengkuo Lee
GlobalFoundries Chair Professor
Director of Center for Intelligent Sensors and MEMS
National University of Singapore

Chengkuo Lee